

Würth Elektronik eiSos GmbH & Co. KG

EMC & Inductive Solutions

Max-Eyth-Straße 1 · 74638 Waldenburg · Germany

Tel. +49 (0) 79 42 945-0 · Fax +49 (0) 79 42 945-400

eiSos@we-online.de · www.we-online.de



Product / Process Change Notification (PCN)

- Major change
 Minor change

PCN #: PCN_WL-SMTW_20200602

Affected Series: WL-SMTW_150224xx73100

PCN Date: March 02, 2020

Effective Date: June 02, 2020

Change Category:

- Equipment / Location
 General Data
 Material
 Process
 Product Design
 Shipping / Packaging
 Supplier
 Software

Contact: Product Management

Phone: +49 (0) 7942 - 945 5001

Fax: +49 (0) 7942 - 945 5179

E-Mail: pcn.eisos@we-online.com

Data Sheet Change:

- Yes No

Attachment:

- Yes No

DESCRIPTION AND PURPOSE OF CHANGE:

In order to improve lead times and capability, Würth Elektronik will implement additional production line.

There will be no change in form, fit, function, quality, or reliability of the product.

All applicable products with date code 2020-05-01 or later, will be affected by the following changes.

DETAIL OF CHANGE:

Neither quality, electrical nor mechanical properties of the parts will be changed. No datasheet change.

All dimensions and standard packaging quantity will remain the same.

Production lines can be identified by the first three digits of the lot number **XXX** XX XXX XXXX XXX.

Lot No. of established production line:

Lot number starting with 384

Country of Origin: Korea

Lot No. of additional production line:

Lot number starting with 278

Country of Origin: China

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**RELIABILITY / QUALIFICATION SUMMARY:**

Product approval is according to the specification and is internally released by the Product Management Department

No.	Test	Qty	Reference	Test conditions
1	Reflow test	30	Internal Reflow Profile according to J-STD-020C	Unsoldered WE Reflow Profile: (at least 3 times must be passed) Peak: TP +5°C Conditions: Preheat: 150-200°C (max 120s) Liquidus temperature: 217°C (max 60s) Peak Temperature: 250°C (10s +/-2s)
2	Life-span in high temperature	30	Internal Spec.	Dehumidification in 125 °C for 2 hours 30 mins @ 25°C Measurement: 1,2,3,4,5 On board for 1 time Reflow Test conditions: Forward current: 30mA @ 125°C in 96h
3	Thermal Shock	30	MIL-STD-202 Method 107	Temperature: -40°C/+125°C or individual specified operating temperature Dwell time: 30 minutes. Cycles: 40 Transfer time: max. 20s
4	ESD Characterization	30	AEC - Q101-001 Rev-A.	2000V for AlInGaP 1000V for InGaN forward pulse: 3 times reversed pulse: 3 times pulse width: 1 second
5	Vibration	30	MIL-STD-202 Method 204	20g's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 100mm x 160mm x 1,5mm PCB-Board. Test from 25-2000 Hz.